

Description

The DFI600HF17I4RE1 is a Half Bridge IGBT Power Module. It integrates high performance IGBT chips designed for the applications such as High Power supply and Motor control.



Features

- Blocking voltage:1700V
- Low saturation voltage $V_{CE(sat)}$
- Low Switching Losses
- 150°C maximum junction temperature
- Thermistor inside

Applications

- High Power Switching Applications
- Motor Drives
- Solar inverter Systems
- Wind Turbines

Circuit diagram

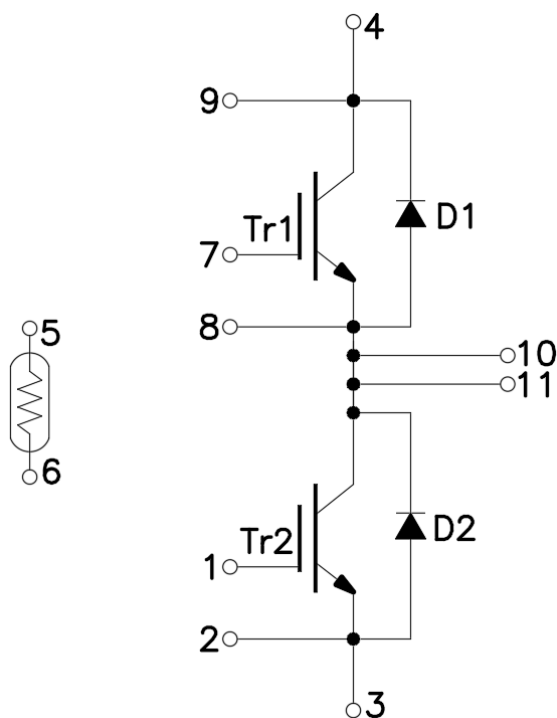


Figure 1. Out drawing & circuit diagram for DFI600HF17I4RE1

Pin Configuration and Marking Information

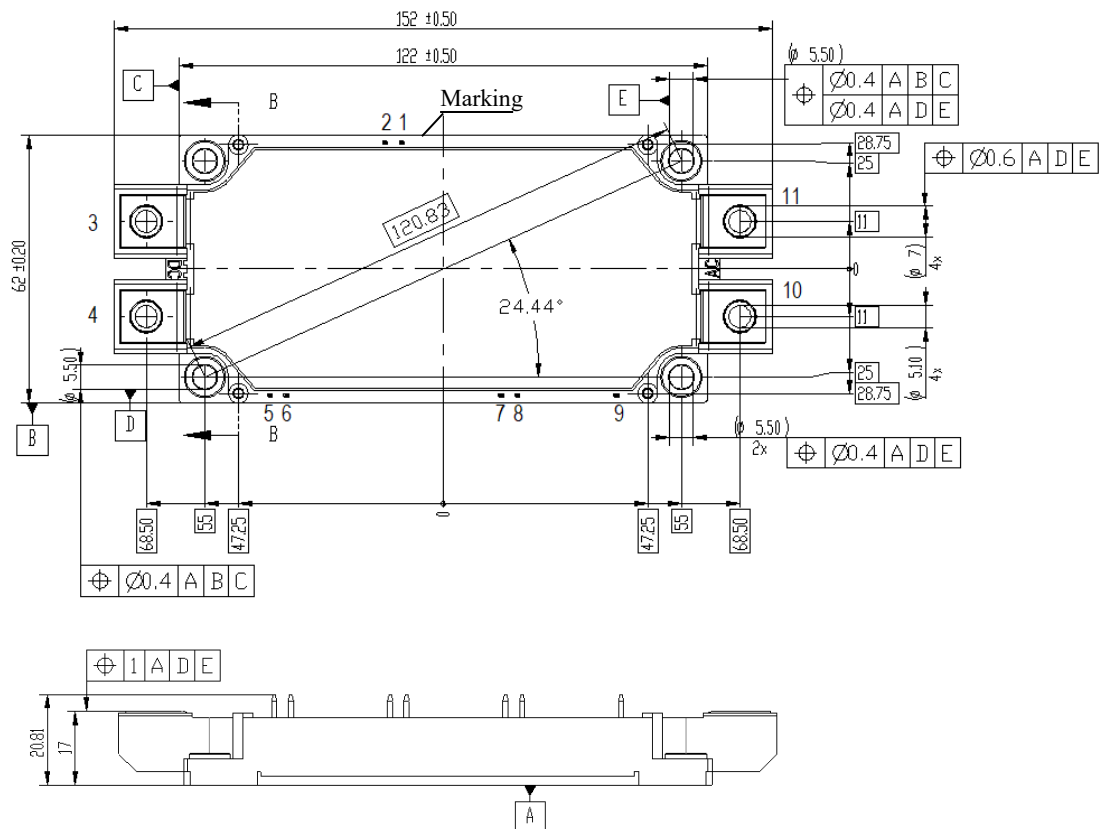


Figure 2. Pin configuration

Module

Parameter	Conditions	Value	Unit
Isolation Voltage	RMS, f = 50Hz, t =1 min	3.4	KV
Material of module baseplate	-	Cu	-
Creepage distance	terminal to heatsink terminal to terminal	14.5 13	mm
Clearance	terminal to heatsink terminal to terminal	12.5 10	mm
CTI	-	>225	-
Module lead resistance, terminals–chip	T _c =25°C	0.8	mΩ
Mounting torque for module mounting	M5, M6	3 to 6	Nm
Weight	-	420	g

Maximum Ratings (T_j=25°C unless otherwise specified)

Symbol	Parameter	Conditions	Ratings	Unit
V _{CES}	Collector-Emitter Voltage	G-E Short	1700	V
V _{GES}	Gate-Emitter Voltage	C-E Short	±20	V
I _C	DC Continuous Collector Current	T _C =100°C	650	A
I _{CM}	Pulse Collector Current	t _p =1ms, Note1	1300	A
P _C	Maximum Power Dissipation	T _C =25°C, T _j =150°C(IGBT)	3906	W
I _F	Diode Forward Current	-	650	A
I _{FRM}	Repetitive peak forward Current	t _p =1ms, Note1	1300	A
I ² t	I ² t-value	V _R =0V, t _p =10ms, T _j =125°C (Diode)	36000	A ² s
T _j	junction temperature	-	-40 to 150	°C
T _{stg}	Storage temperature	-	-40 to 125	°C

Note1: Pulse width limited by maximum junction temperature

NTC characteristics

Symbol	Parameter	Condition	Value			Unit
			Min.	Typ.	Max.	
R ₂₅	Resistance	T _C =25°C	-	5	-	kΩ
ΔR/R	Deviation of R ₁₀₀	T _C =100°C, R ₁₀₀ =493Ω	5	-	5	%
P ₂₅	Power dissipation	T _C =25°C	-	-	20	mW
B _{25/50}	B-value	$R_2 = R_{25} \exp [B_{25/50}(1/T_2 - 1/(298,15 \text{ K}))]$	-	3375	-	K
B _{25/80}	B-value	$R_2 = R_{25} \exp [B_{25/80}(1/T_2 - 1/(298,15 \text{ K}))]$	-	3411	-	K
B _{25/100}	B-value	$R_2 = R_{25} \exp [B_{25/100}(1/T_2 - 1/(298,15 \text{ K}))]$	-	3433	-	K

IGBT Electrical characteristics (T_j=25°C unless otherwise specified, chip: Target)

Symbol	Item	Condition		Value			Unit
				Min.	Typ.	Max	
V _{CE(sat)} (Chip)	Collector-Emitter Saturation Voltage	I _C =600A V _{GE} =15V	T _J =25°C	-	1.6	1.9	V
			T _J =125°C	-	1.95	-	V
			T _J =150°C	-	2.03	-	V
V _{GE(th)}	Gate-Emitter threshold Voltage	I _C =24mA, V _{CE} =V _{GE}		5.2	5.8	6.4	V
Q _G	Gate charge	V _{GE} = -15V to +15V		-	6.2	-	uC
R _{Gint}	Internal gate resistor	-	T _J =25°C	-	1.7	-	Ω
C _{ies}	Input Capacitance	V _{CE} =25V, V _{GE} =0V f =1MHz	T _J =25°C	-	49.5	-	nF
C _{res}	Reverse transfer Capacitance			-	0.75	-	nF
I _{CES}	Collector- Emitter Cut off Current	V _{CE} =1700V, V _{GE} =0V	T _J =25°C	-	-	1	mA
I _{GES}	Gate-Emitter Leakage Current	V _{GE} =20V, V _{CE} =0V	T _J =25°C	-	-	1.8	uA
t _{d(on)}	Turn-on delay time	V _{CC} =900V I _C = 600A V _{GE} =+15V/-8V R _G =1.0Ω Inductive load	T _J =25°C	-	205	-	ns
			T _J =150°C	-	207	-	
t _r	Rise time		T _J =25°C	-	125	-	ns
			T _J =150°C	-	188	-	
t _{d(off)}	Turn-off delay time		T _J =25°C	-	570	-	ns
			T _J =150°C	-	735	-	
t _f	Fall time		T _J =25°C	-	370	-	ns
			T _J =150°C	-	680	-	
E _{on}	Turn-on power dissipation		T _J =25°C	-	234	-	mJ
			T _J =150°C	-	383	-	
E _{off}	Turn-off power dissipation		T _J =25°C	-	134	-	mJ
			T _J =150°C	-	205	-	
I _{SC}	SC data	V _{GE} <15V V _{CC} =1000V	T _J =150°C t _p <10us	-	3000	-	A
R _{th(j-c)}	Thermal Resistance, Junction to Case (IGBT)			-	0.032	-	°C /W
R _{th(c-s)}	Thermal Resistance, Case to sink (Conductive Grease applied)			-	0.015	-	°C /W

Freewheeling Diode Electrical characteristics (T_j=25°C unless otherwise specified, chip:

Target)

Symbol	Item	Condition		Value			Unit
				Min.	Typ.	Max	
V _F	Diode Forward Voltage	I _F =600A V _{GE} =0V	T _j =25°C	-	1.8	2.1	V
			T _j =150°C	-	1.75	-	
t _{rr}	Reverse recovery time	(Switch side) V _{CC} =900V, I _C =600A	T _j =25°C	-	1.08	-	us
			T _j =150°C	-	1.51	-	
I _{RM}	Peak reverse recovery Current	V _{GE} =+15V/-8V R _G =1.0Ω	T _j =25°C	-	270	-	A
			T _j =150°C	-	333	-	
Q _{rr}	Recovered charge	(FRD side) V _{rr} =900V, I _F =600A V _{GE} =+15V/-8V	T _j =25°C	-	112	-	uC
			T _j =150°C	-	244	-	
E _{rr}	Reverse recovered energy	Inductive load switching operation	T _j =25°C	-	53	-	mJ
			T _j =150°C	-	125	-	
R _{th(j-c)}	Thermal Resistance, Junction to Case (Diode)			-	0.042	-	°C/W
R _{th(c-s)}	Thermal Resistance, Case to sink (Conductive Grease applied)			-	0.015	-	°C/W

Test Conditions

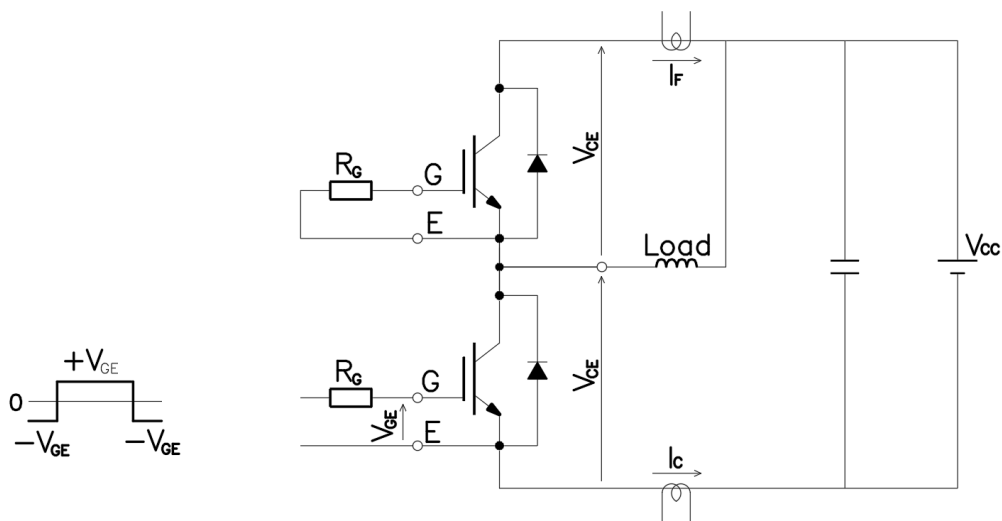


Figure 3. Switching time measure circuit

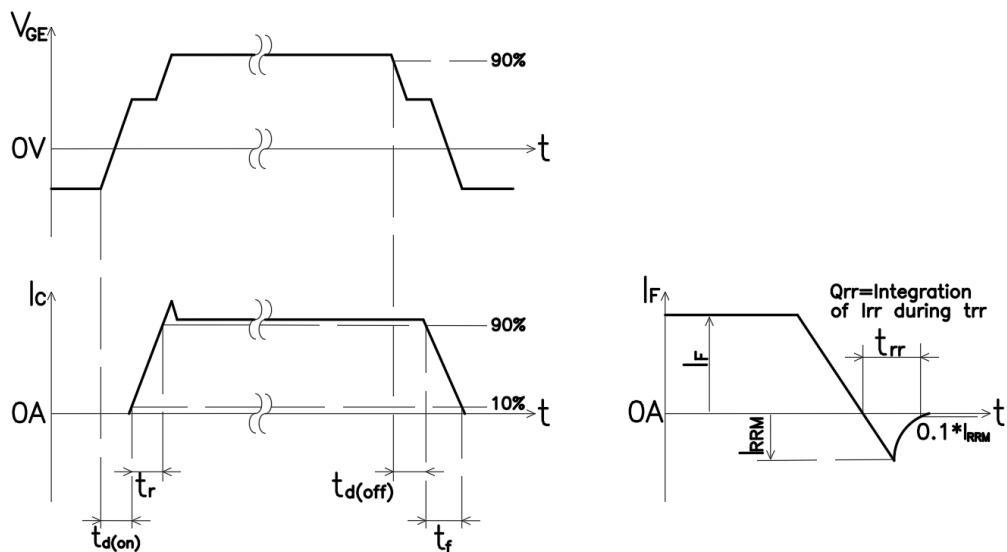


Figure 4. Switching time definition

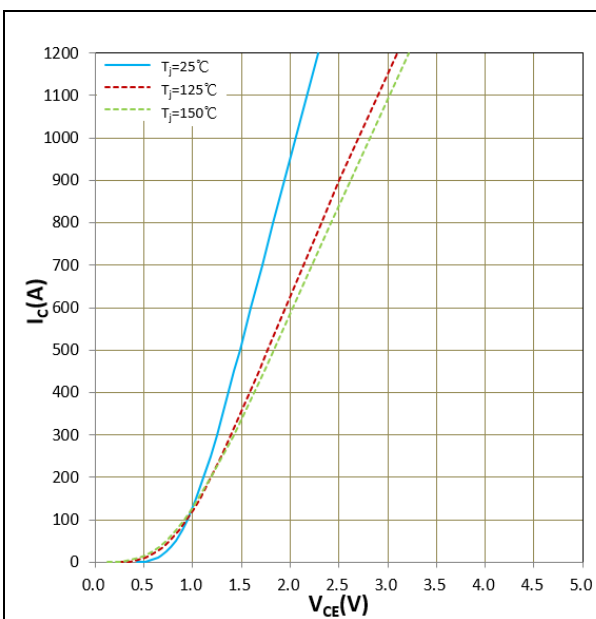


Figure 5. I_C vs V_{CE}
 $V_{GE} = 15V$

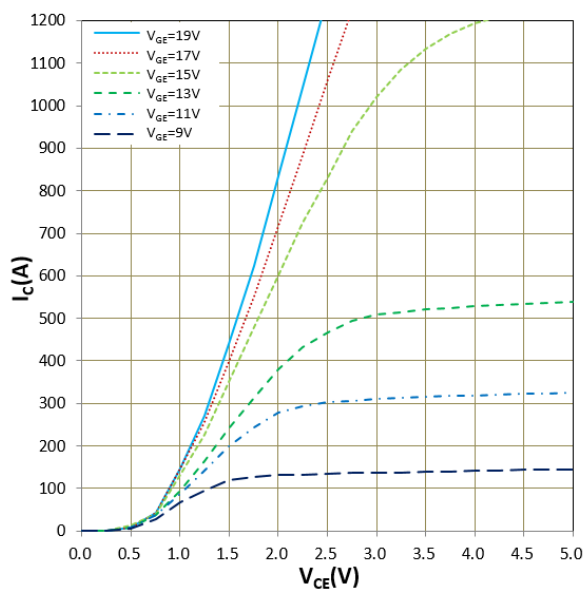


Figure 6. I_C vs V_{CE}
 $T_J = 150^\circ C$

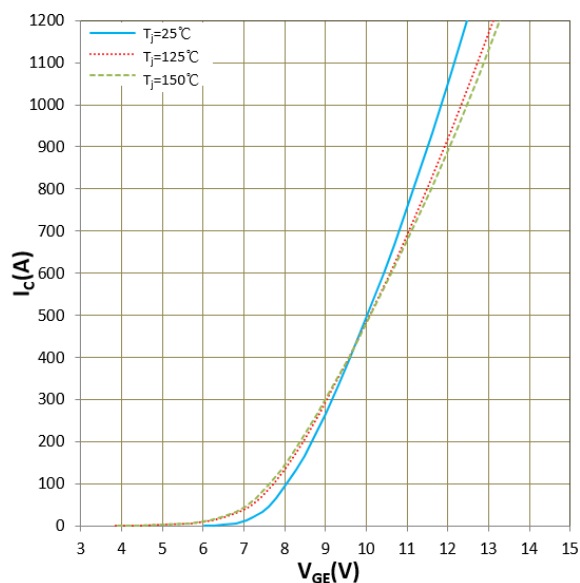


Figure 7. I_c vs V_{GE}
 $V_{CE}=20V$

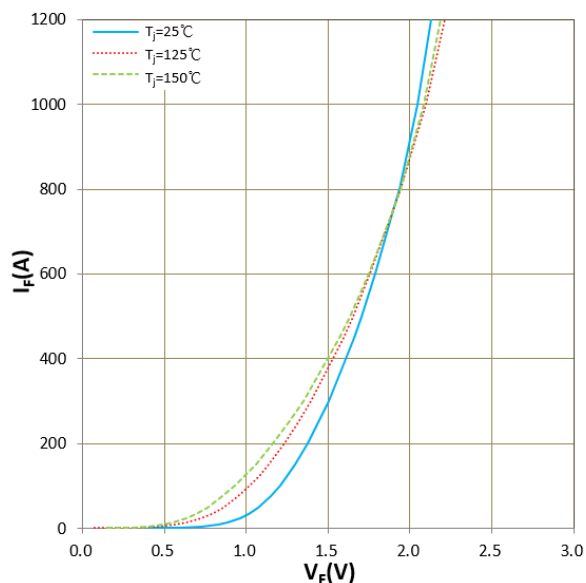


Figure 8. I_F vs V_F

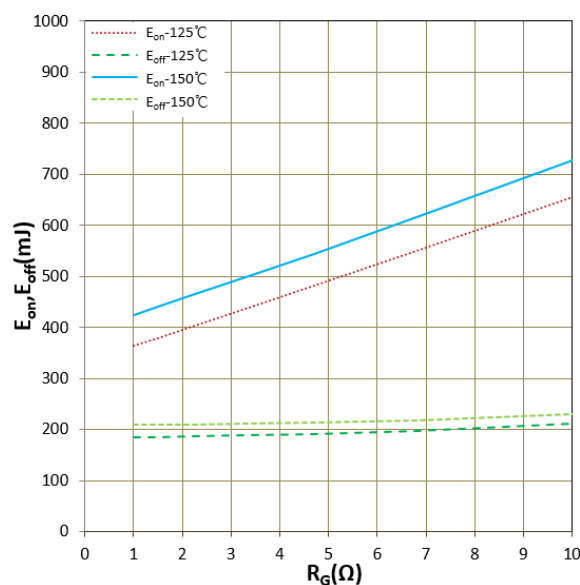


Figure 9. E_{on} , E_{off} vs R_G (Typ)
 $V_{CC}=900V$, $V_{GE}=+15V/-8V$, $I_c = 600A$
Inductive Load

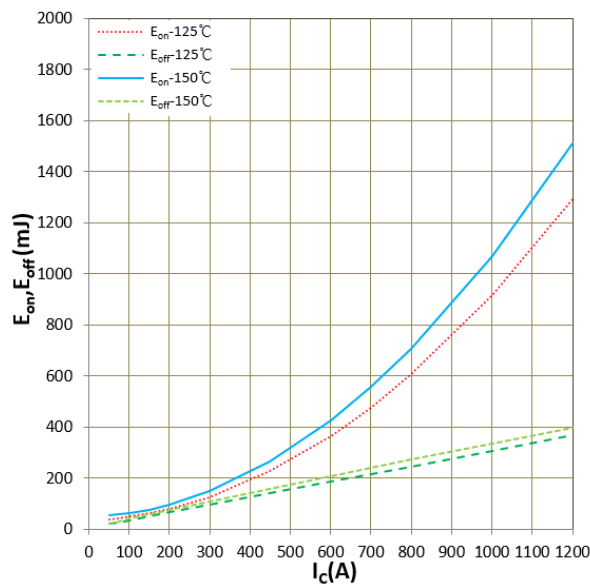


Figure 10 E_{on} , E_{off} vs I_c (Typ)
 $V_{CC}=900V$, $V_{GE}=+15V/-8V$, $R_G=1.0\Omega$
Inductive Load

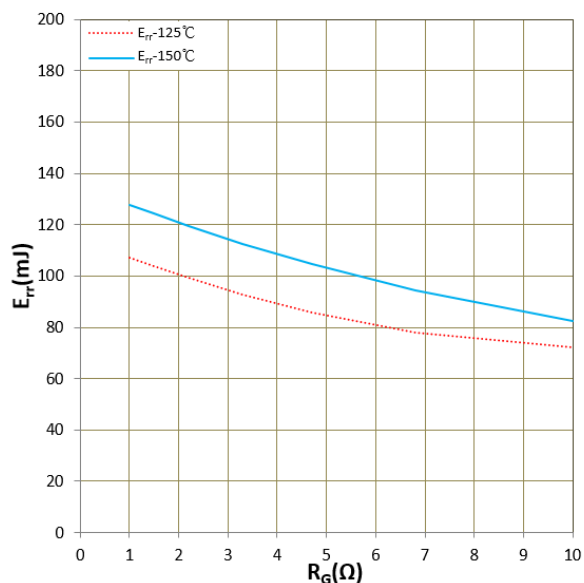


Figure 11. Err vs R_G (Typ)
 $V_{CC}=900V$, $V_{GE}=+15V/-8V$, $I_F=600A$
 Inductive Load

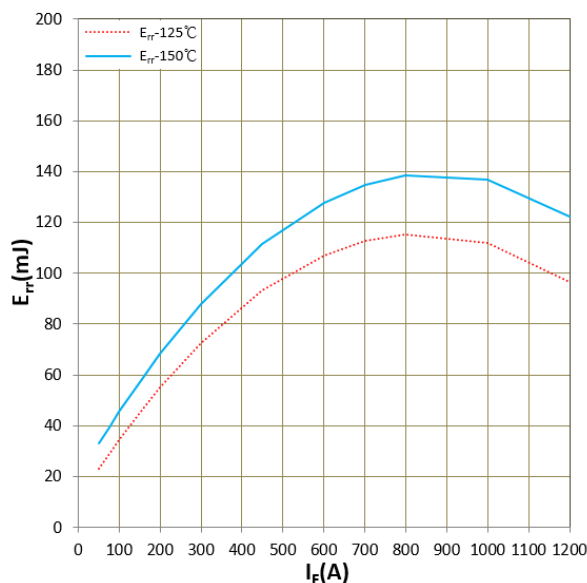


Figure 12. E_{rr} vs I_F (Typ)
 $V_{CC}=900V$, $V_{GE}=+15V/-8V$, $R_G=1.0\Omega$
 Inductive Load

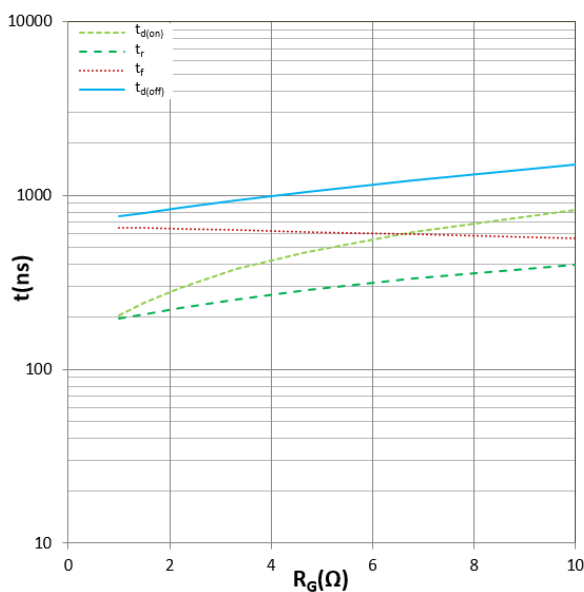


Figure 13. Switching time vs R_G (Typ)
 $V_{CC}=900V$, $V_{GE}=+15V/-8V$, $I_C=600A$
 $T_J=150^\circ C$, Inductive Load

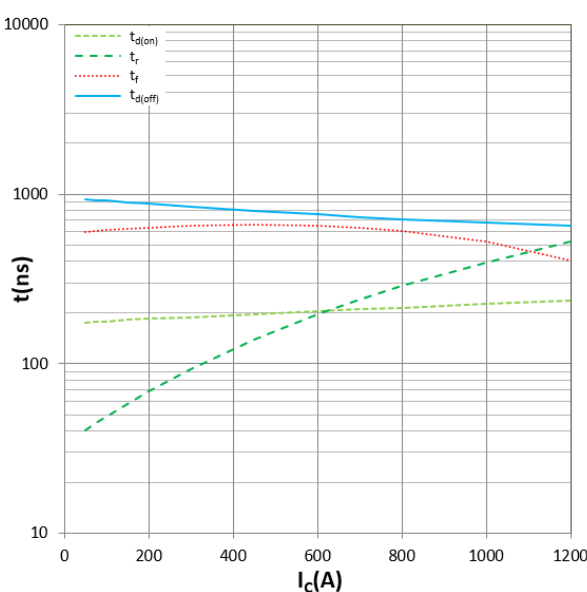


Figure 14. Switching time vs I_C (Typ)
 $V_{CC}=900V$, $V_{GE}=+15V/-8V$, $R_G=1.0\Omega$
 $T_J=150^\circ C$, Inductive Load

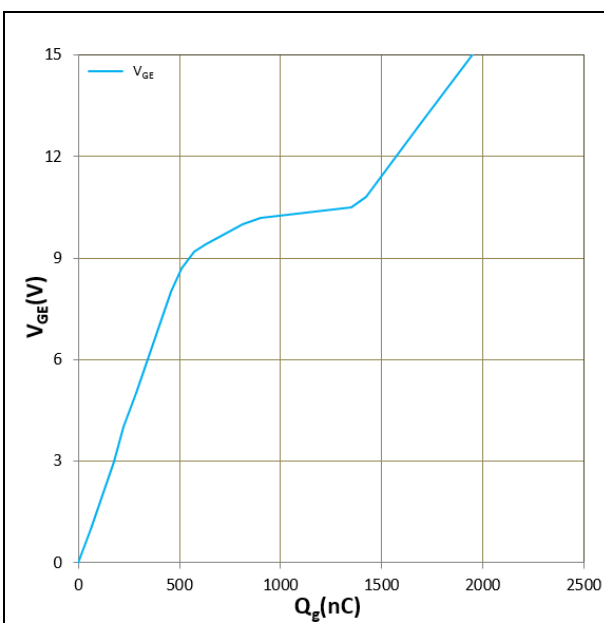


Figure 15. Gate charge

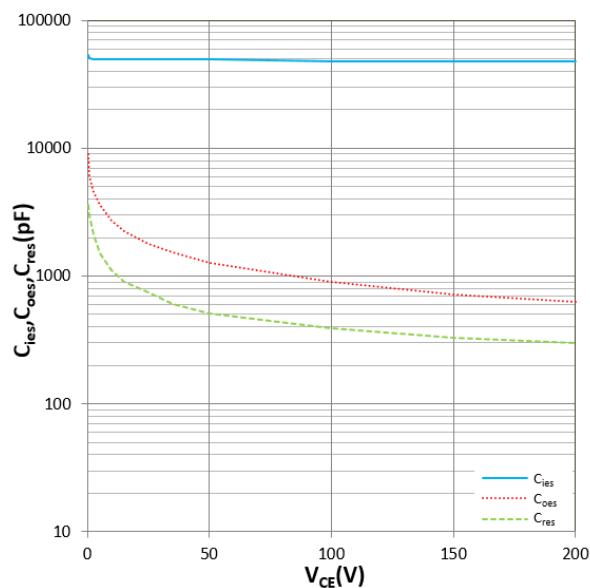


Figure 16. C_{ies} , C_{oes} , C_{res} vs V_{CE}
 $T_j = 25^\circ\text{C}$, $f = 1\text{MHz}$

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This product data sheet describes the characteristics of this product for which a warranty is granted. Any such warranty is granted exclusively under the terms and conditions of the supply agreement. There will be no guarantee or of any kind for the product and its characteristics.

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